TAP1000 & 2000

1000 & 2000 Watt Heat Sinkable Planar



The TAP series delivers 1000W or 2000W of continuous power when properly mounted to a liquid cooled heat sink (based on 85°C mounting plate temperature)

Applications include power conditioning, power distribution, power conversion, and power control.

RoHS Compliant

FEATURES

- High Energy Rating
- Low Inductance
- Resistor Element Electrically Isolated
- High Dielectric Strength
- Small Footprint

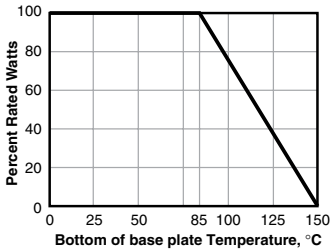
APPLICATIONS

- Power semiconductor balancing
- Motor control
- Inrush Current Limiting

CHARACTERISTICS

Resistor Element	Thick Film on Alumina Substrate
Power Rating	1000W or 2000W at 85°C mounting plate
Resistance Values	0.5Ω to 1000Ω
Resistance Tolerance	+10% std.
Max Operating Voltage	2000VDC
Temperature Coefficient	± 250 PPM/°C
Dielectric Strength	6KV standard
Operating Temperature Range	-55°C to 85°C
Terminal Screws	#10-32
Max Contacts Torque	10 in-lb
Mounting Screws	#8-32
Max Mounting Torque	15 in-lb
Creepage Distance	50mm ± 1mm (min)

Derating



Test	Rating Continuous	Pulse
Rated Power, max. current and heat sink plate temperature limited	(TA1K0) 1000W (TA2K0) 2000W	
Operating Voltage	√P*R	N/A
Max. Applied Voltage, ohms law limited	223V	2000VDC
Max. Current	10A	53.33A
Critical Resistance; below this resistance max power has to be de-rated due to exceeding max current	(TA1K0) 10Ω (TA2K0) 20Ω	

Test	Method	Maximum ΔR
Short Time Overload	1.14 x √P*R / 10 sec @ 70°C	Max % ΔRsto = ±(2% + 0.05Ω)
Moisture Resistance	(TA1K0) 1000 hrs @ 40°C, 90-95% RH (TA2K0) 1750 hrs @ 40°C, 90-95% RH	≤1% ≤1%
Thermal Shock	MIL-STD-202, Method 107	MIL-STD-202, Method 107
Vibration, elec.	MIL-STD-202, Method 201	±2% Resistance
Vibration, mech.	MIL-STD-202, Method 201	No Loose Terminal Screws
Load Life	(TA1K0) 1000 Hrs 90 min ON / 30 min OFF (TA2K0) 1750 Hrs 90 min ON / 30 min OFF	≤1% ≤1%
Pulse Tolerance	52µF @ 2KV / 60 sec intervals, 104J, 20,000 Pulses	≤1%
Dielectric Strength	6KVDC for 1 minute	≤1%

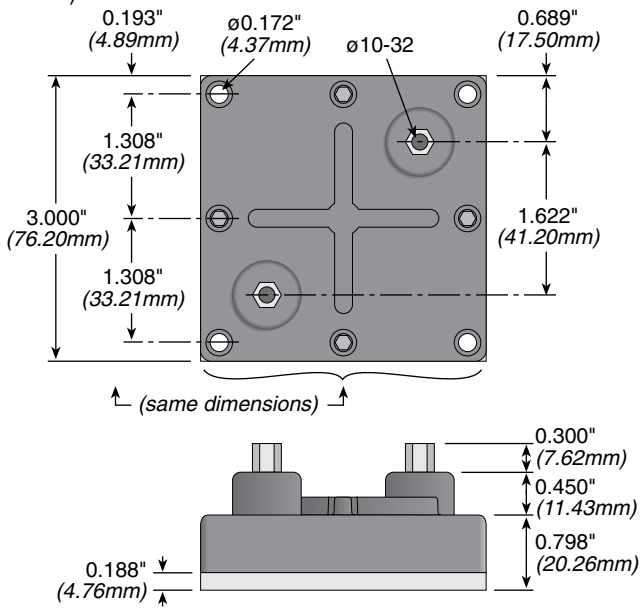
(continued)

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DIMENSIONS

(in./mm)



APPLICATION NOTES

Proper heat sinking techniques are essential to performance of a TAP resistor. Pleased follow these guidelines when designing TAP system:

- Heats sink plate (base plate of the resistor) temperature must be monitored to establish proper de-rating. Best technique is to attach a thermocouple to the side of the base plate of the resistor. Temperature of plastic housing or heat sink cannot be used to establish rating of the resistor. Usage of laser thermometers should be avoided.
- To obtain a power rating of 1000W or 2000W, the bottom case temp must not exceed 85°C. This can only be achieved if the thermal conduction to the heatsink Rth-cs<0.025°K/W. This value can be reached by using thermal transfer compound with a heat conductivity of 1W/mK. The flatness of the cooling plate must be better than 0.05mm overall. The roughness of the surface should not exceed 6.4µm.
- Due to very high power density, only liquid cooled heat sinks are recommended for applications when >300W power rating is desired.
- Properly designed heat sink should have more than 2 cooling pipes under the surface of the TAP resistor. The Hydroblok, a 4 pass aluminum heat sink (http://www.ohmite.com/ta1k0-sink.html) is an example of properly designed heat sink.

ORDERING INFORMATION

RoHS Compliant

TA 1K0 PH 2R50 K E

Style	Wattage	Package Type	Resistance	Tolerance
			2.5Ω = 2R50 50Ω = 50R0	K = 10% (standard) L = 20%

Standard Part Numbers

Ohms	1000 Watt 10% Tolerance	Ohms	2000 Watt 10% Tolerance
0.5	TA1K0PHR500KE	0.5	TA2K0PHR500KE
1	TA1K0PH1R00KE	1	TA2K0PH1R00KE
2.5	TA1K0PH2R50KE	2.5	TA2K0PH2R50KE
5	TA1K0PH5R00KE	5	TA2K0PH5R00KE
7.5	TA1K0PH7R50KE	7.5	TA2K0PH7R50KE
10	TA1K0PH10R0KE	10	TA2K0PH10R0KE
15	TA1K0PH15R0KE	15	TA2K0PH15R0KE
25	TA1K0PH25R0KE	25	TA2K0PH25R0KE
50	TA1K0PH50R0KE	50	TA2K0PH50R0KE
100	TA1K0PH100RKE	100	TA2K0PH100RKE
250	TA1K0PH250RKE	250	TA2K0PH250RKE
500	TA1K0PH500RKE	500	TA2K0PH500RKE
750	TA1K0PH750RKE	750	TA2K0PH750RKE
1000	TA1K0PH1K00KE	1000	TA2K0PH1K00KE